Amendments to the Specification:

Please amend paragraph [0041] beginning on page 16, line 4 as follows:

[0041] The imaging element 4 provides a small output voltage and thus is susceptible to the influence of noise. On the other hand, the driving element 6 causes a high level of noise because a current and a voltage vary widely in the driving element 6 due to PWM switching or the like. Accordingly, when the imaging element 4 and the driving element 6 are arranged in close proximity to each other, the noise caused by the driving element 6 influences the imaging element 4 so that a good image cannot be obtained. Thus, by arranging the imaging element 4 and the driving element 6 so that they are spaced apart from each other as shown in FIGs. 3 and 4, it is possible to reduce the influence of the noise on the imaging element 4. It is to be noted here that, in the case where blocks respectively serving as the imaging element 4, the controlling element 5, and the driving element 6 are mounted on a single chip, it is also desirable that the block serving as the ~~driving~~ imaging element 4 and the block serving as the driving element 6 are arranged so that they are spaced apart from each other.

Please amend paragraph [0085] beginning on page 33, line 7 as follows:

[0085] The ~~upper~~ lower spring [[241a]] 241b is arranged on a side closer to the imaging element 4 (see FIG. 1) with respect to the center in the optical axis direction of the lens 211 and couples the lens portion 210 and the fixed base 230. The ~~lower~~ upper spring [[241b]] 241a is arranged on a side opposite to the side closer to the imaging element 4 with respect to the center in the optical axis direction of the lens 211 and couples the lens portion 210 and the fixed base 3 (see FIG. 1).

Please amend paragraph [0123] beginning on page 45, line 22 as follows:

[0123] The coupling portion 540 has the upper spring 541a, the lower spring 541b, an inner-side upper part stopper 543a, an inner-side lower part stopper 543b, an outer-side upper part stopper 544a, and an outer-side lower part stopper 544b. The upper spring 541a and the lower spring 541b are formed of a metal that has high electrical conductivity and is highly resistant to metal fatigue, such as a beryllium copper alloy, and

can be obtained by punching out a plate-like member formed of such a metal into a predetermined shape with a press or the like. The ~~upper~~ lower spring [[541a]] 541b is arranged on a side closer to the imaging element 4 (see FIG. 1) with respect to the center in the optical axis direction of the lenses 511a, 511b, 511c, and 511d and couples the lens portion 510 and the fixed base 230. The ~~lower~~ upper spring [[541b]] 541a is arranged on a side opposite to the side closer to the imaging element 4 with respect to the center in the optical axis direction of the lenses 511a, 511b, 511c, and 511d and couples the lens portion 510 and the fixed base 230.